SiHH14N65EF

Vishay Siliconix

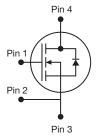


PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	700					
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.236				
Q _g max. (nC)	98					
Q _{gs} (nC)	11					
Q _{gd} (nC)	20					
Configuration	Single					

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PowerPAK[®] 8 x 8





N-Channel MOSFET

FEATURES

- Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION					
Package	PowerPAK 8 x 8				
Lead (Pb)-free and Halogen-free	SiHH14N65EF-T1-GE3				

ABSOLUTE MAXIMUM RATINGS ($T_c = 25$ °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V _{DS}	650	v			
Gate-Source Voltage	V _{GS}	± 30	V			
Continuous Drain Current (T _J = 150 °C)	$V_{GS} \text{ at } 10 \text{ V} \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	- I _D	15			
	$T_{\rm C} = 100 ^{\circ}{\rm C}$		9.5	А		
Pulsed Drain Current ^a	I _{DM}	36				
Linear Derating Factor		1.25	W/°C			
Single Pulse Avalanche Energy ^b	E _{AS}	226	mJ			
Maximum Power Dissipation	PD	156	W			
Operating Junction and Storage Temperature Ran	T _J , T _{stg}	-55 to +150	°C			
Drain-Source Voltage Slope	T _J = 125 °C	dV/dt	70	V/ns		
Reverse Diode dV/dt c	uv/di	18	v/ns			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4 A.
- c. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	42	55			0044		
Maximum Junction-to-Case (Drain)	R _{thJC}	0.57 0.80				°C/W		
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static						•		<u> </u>
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 10 mA	-	0.73	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = 2$	250 µA	2.0	-	4.0	V
Cata Cauraa Laakaaa		1	$I_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Gate-Source Leakage	IGSS	1	$I_{\rm GS} = \pm 30$	V	-	-	± 1	μA
Zana Oata Maltana Duain Orimont		V _{DS} =	520 V, V _G	_S = 0 V	-	-	1	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 520 V	, V _{GS} = 0 V	′, T _J = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I	_D = 7 A	-	0.236	0.271	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 7 A		-	6.0	-	S	
Dynamic		• •				•	•	•
Input Capacitance	C _{iss}		$V_{GS} = 0 V_{S}$	_	-	1749	-	
Output Capacitance	C _{oss}	۱ ۱	$V_{\rm DS} = 0.0$ V, $V_{\rm DS} = 100$ V,		-	82	-	1
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	4	-	рF	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{\rm DS}$ = 0 V to 520 V, $V_{\rm GS}$ = 0 V		-	57	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	228	-		
Total Gate Charge	Qg				-	49	98	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 7 \text{ A}, V_{DS} = 520 \text{ V}$		-	11	-	nC	
Gate-Drain Charge	Q _{gd}				-	20	-	1
Turn-On Delay Time	t _{d(on)}				-	21	42	
Rise Time	t _r		= 520 V, I _D		-	28	56	- ns
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	10 V, R _g =	= 9.1 Ω	-	56	84	
Fall Time	t _f				-	29	58	
Gate Input Resistance	R _g	f = 1 MHz, open drain		0.35	0.70	1.4	Ω	
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15	A	
Pulsed Diode Forward Current	I _{SM}			-	-	36		
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 7 A,	$V_{GS} = 0 V$	-	0.9	1.2	V
Deveree Decevery Time	•			1	400	040	ns	
Reverse Recovery Time	t _{rr}				-	120	240	115
Reverse Recovery Time Reverse Recovery Charge	t _{rr} Q _{rr}	$T_J = 2$	5 °C, I _F = Ig 100 A/µs, \	_S = 7 A, / ₂ = 25 V	-	0.6	1.2	μC

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

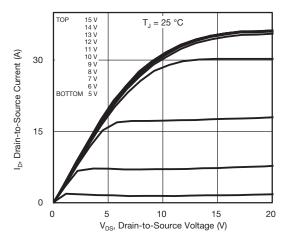


Fig. 1 - Typical Output Characteristics

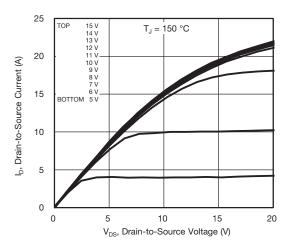
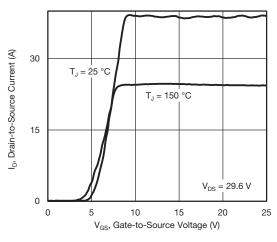


Fig. 2 - Typical Output Characteristics





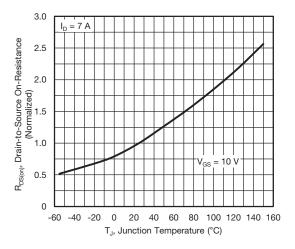


Fig. 4 - Normalized On-Resistance vs. Temperature

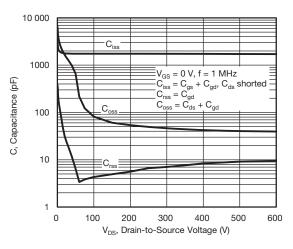


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

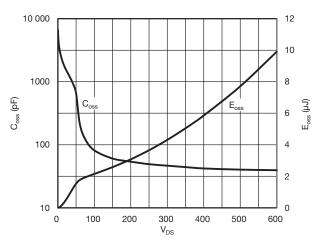


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

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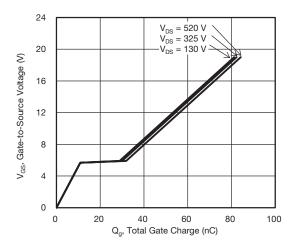


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

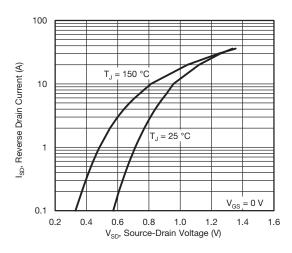


Fig. 8 - Typical Source-Drain Diode Forward Voltage

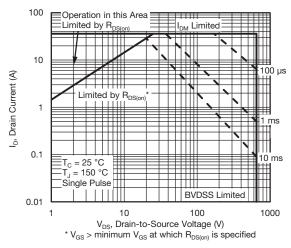


Fig. 9 - Maximum Safe Operating Area

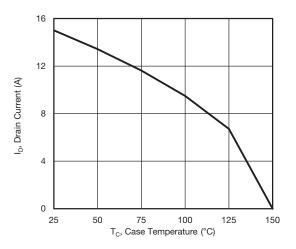


Fig. 10 - Maximum Drain Current vs. Case Temperature

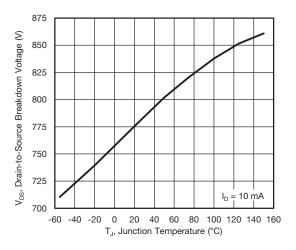


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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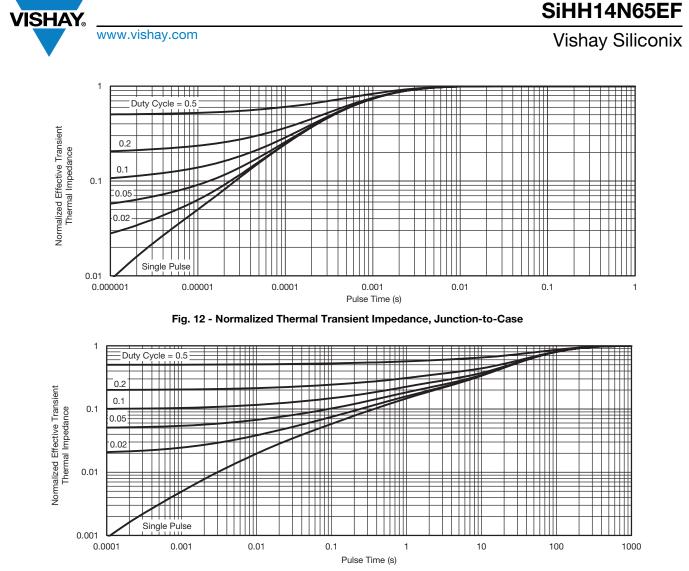


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

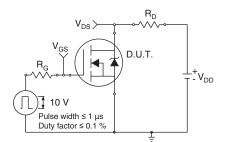


Fig. 14 - Switching Time Test Circuit

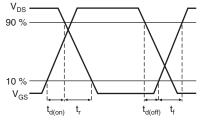


Fig. 15 - Switching Time Waveforms

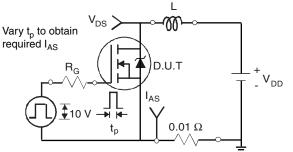
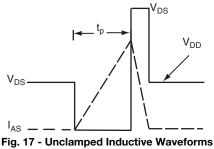


Fig. 16 - Unclamped Inductive Test Circuit

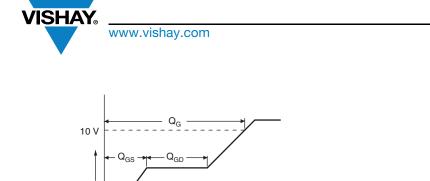


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Charge —

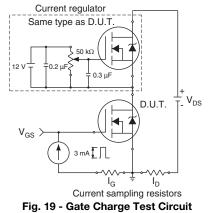
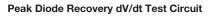


Fig. 18 - Basic Gate Charge Waveform

V_G



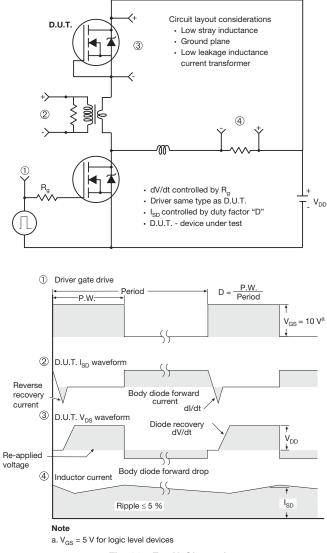


Fig. 20 - For N-Channel

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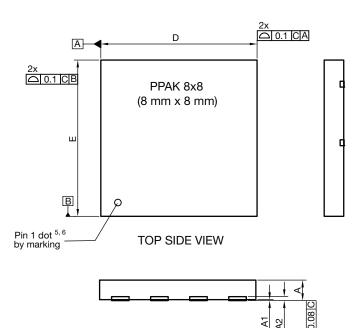
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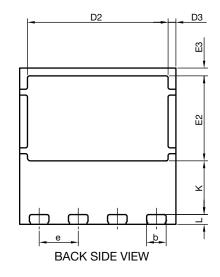
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PowerPAK[®] 8 x 8 Case Outline





DIM.	MILLIMETERS			INCHES				
Dilvi.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
A ⁸	0.95	1.00	1.05	0.037	0.039	0.041		
A1	0.00	-	0.05	0.000	-	0.002		
A2		020 ref.			0.008 ref.			
b ⁴	0.95	1.00	1.05	0.037	0.039	0.041		
D	7.90	8.00	8.10	0.311	0.315	0.319		
D2	7.10	7.20	7.30	0.280	0.283	0.287		
D3		0.40 BSC			0.016 BSC			
e	2.00 BSC		0.079 BSC					
E	7.90	8.00	8.10	0.311	0.315	0.319		
E2	4.30	4.35	4.40	0.169	0.171	0.173		
E3	0.40 BSC			0.016 BSC				
К	2.75 BSC		0.108 BSC					
L	0.45	0.50	0.55	0.018	0.020	0.022		
N ³	8 8							

D

Notes

1. Use millimeters as the primary measurement.

2. Dimensioning and tolerances conform to ASME Y14.5 M - 1994.

3. N is the number of terminals.

4. Package warpage max. 0.08 mm.

5. The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body.

6. Exact shape and size of this feature is optional.

ECN: T15-0225-Rev. A, 18-May-15 DWG: 6041

Revision: 18-May-15

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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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